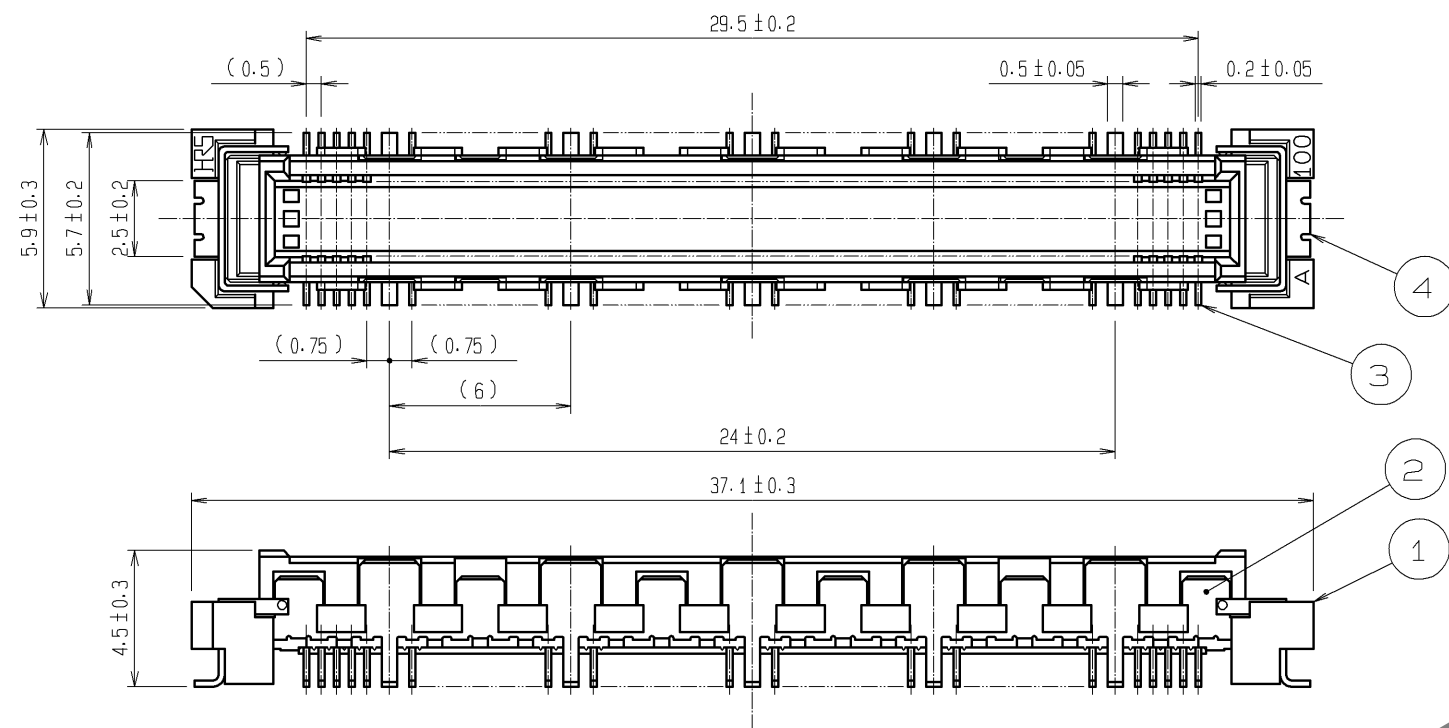
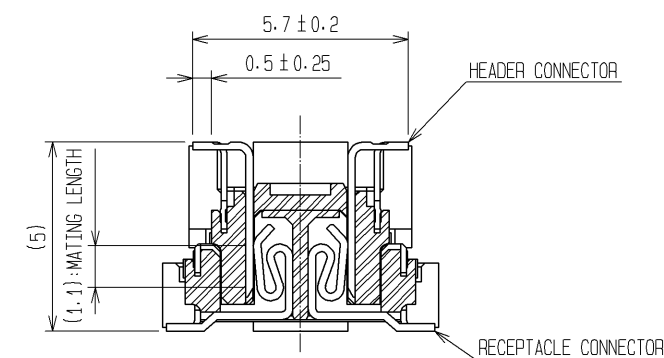


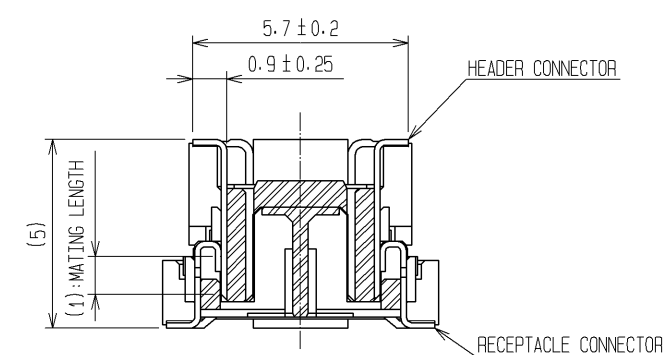


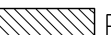
RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)

CROSS CUT SECTION - SIGNAL (5:1)



CROSS CUT SECTION - GROUND (5:1)



- NOTES
- 10 HATCHED  PARTS: GROUND CIRCUIT.
 - 2 HATCHED  PARTS: GROUND CIRCUIT.
 - 3 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 4 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 5 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED  AREA.)
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

2	PHOSPHOR BRONZE	TIN-PLATING	4	PHOSPHOR BRONZE	TIN-PLATING
			3	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1µm min. LEAD AREA: TIN-PLATING 1µm min. UNDER PLATING: NICKEL 1µm min.
1	LCP	BEIGE UL94V-0			
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
UNITS mm			SCALE 4 : 1		
HRS			COUNT		
HIROSE ELECTRIC CO., LTD.			DESCRIPTION OF REVISIONS		
			DESIGNED		
			CHECKED		
			DATE		
APPROVED : HS. OKAWA			08.06.26		
CHECKED : HT. YAMAGUCHI			08.06.25		
DESIGNED : SY. KAMIGA			08.06.23		
DRAWN : HK. SUNADORI			08.06.17		
			DRAWING NO.		
			EDC3-151965-25		
			PART NO.		
			FX10B-100P/10-SV1(71)		
			CODE NO.		
			CL570-0122-0-71		
			1/1		